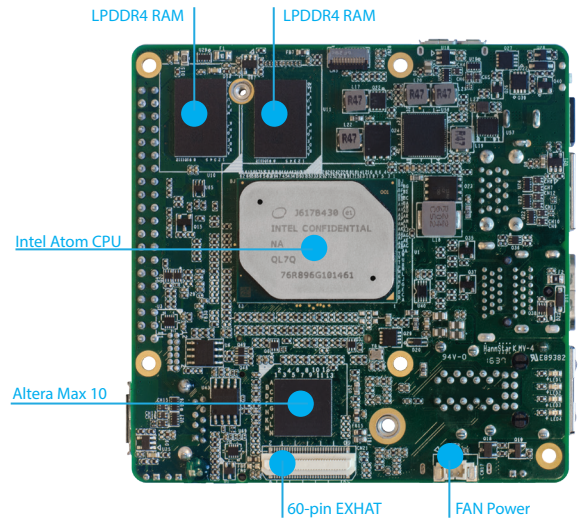
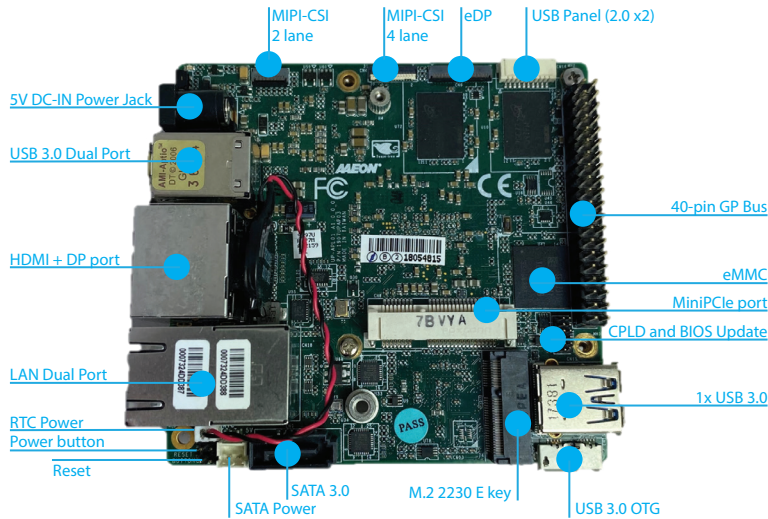




UP² (UP Squared) is world's fastest maker board with the high performance and low power consumption features of **Intel® Celeron™, Pentium™ and Atom™ Processors (codename Apollo Lake)**.

The internal GPU is the new **Intel Gen 9 HD with 12 / 18 Execution Units**, supporting **4K Codec Decode and Encode** for HEVC⁴, H.264 and VP8. Thanks to the Vector Units Image Processing Unit and Precision Timing Management to synchronize CPU with I/O, improved **determinism** (cache QoS, Intel Virtualization Technology), all the graphic processing is effortless to UP² (UP Squared).

UP² (UP Squared) comes with **2GB/4GB/8GB LPDDR4** and **32GB/64GB/128GB eMMC**. A **40-pin GP-bus** provides the freedom for makers to build up their module. Additionally, there is a **60-pin EXHAT** for embedded applications. This allows for the exploration of more possibilities. The expansion capabilities of UP² (UP Squared) goes much further than this. Native **mini-PCI-e, M.2 2230 and SATA3** are all built in on the board. What more could one desire?

The board supports **Windows 10, Windows IoT Core, Ubinlinux, Ubuntu, Yocto and Android Marshmallow**. It's really UP to you to decide which operating system is best for your application. Now, all you need is an UP² (UP Squared) to begin your project!

UP - Applications



Drones



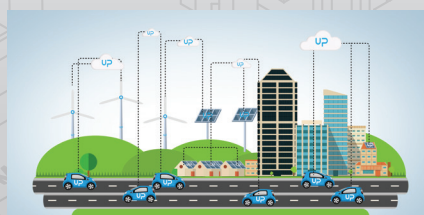
Education



Robotics



Media Center



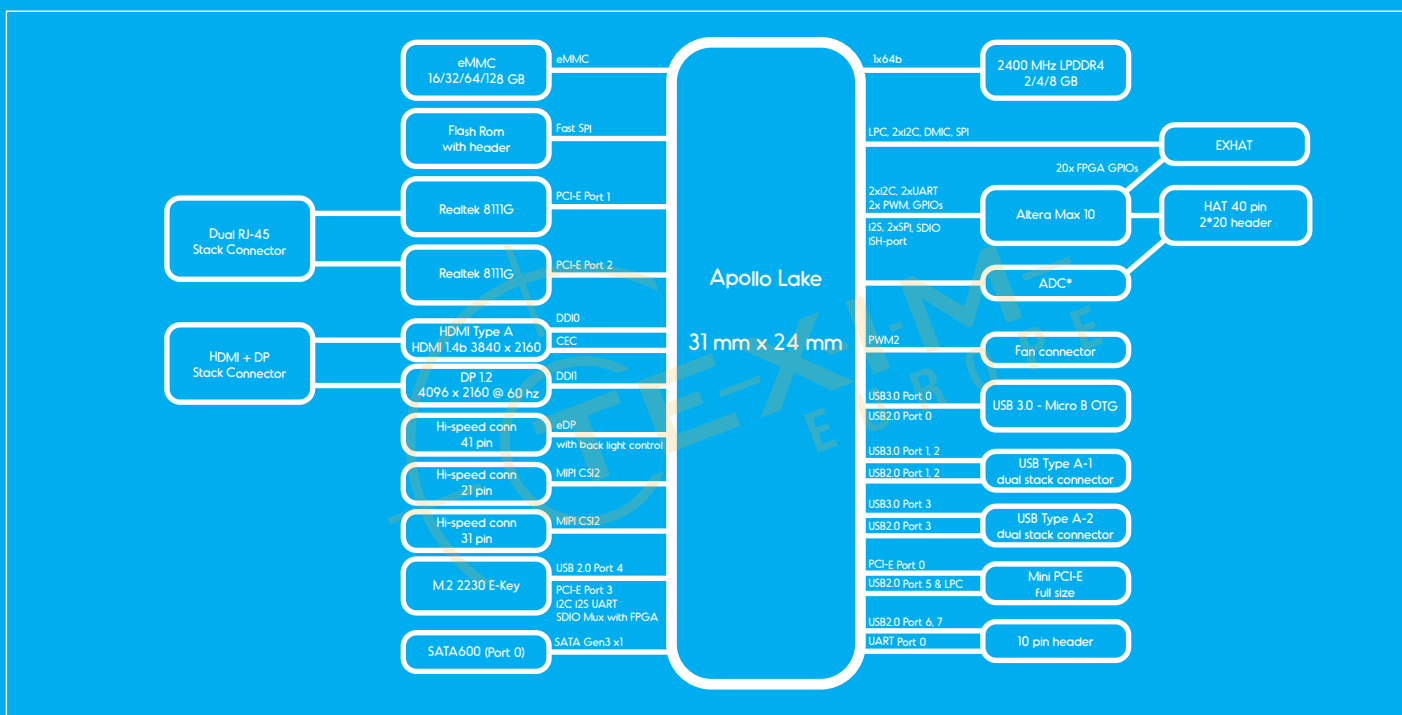
Internet of Things



Home Automation

UP² - Specifications

        	SOC Intel® Celeron™ N3350 (up to 2.4 GHz) Intel® Pentium™ N4200 (up to 2.5 GHz) Intel® Atom™ X5-E3940 / X7-E3950 Graphics Intel® Gen 9 HD, supporting 4K Codec Decode and Encode for HEVC4, H.264, VP8 Video & Audio HDMI 1.4b x1 4K @ 30 hz + DP 1.2 4K @ 60 hz I2S audio port Camera interface MIPI-CSI2 2-lane (2MP) + MIPI-CSI2 4-lane (8MP) Display interface eDP Power 5V DC-in @ 4A-6A Operating humidity 0% ~ 90% relative humidity, non-condensing Operating Temperature 32-140°F / 0-60°C Altera MAX 10 FPGA 2KLE --Celeron/ Pentium 4KLE -- ATOM	         	Memory 2GB/4GB/8GB LPDDR4 Storage Capacity 32 GB / 64 GB / 128 GB eMMC USB 3x UB3.0 (Type A) + 1x USB 3.0 OTG (Micro B) 2x USB2.0+2 X UART (Tx/Rx) debug port (pin header) Ethernet 2x Gb Ethernet (full speed, Realtek 8111G) RJ-45 RTC Yes Expansion 40 pin General Purpose bus + 4-channel 12-bit A/D converter (500 ksp/s to 1 Msps) 60 pin EXHAT 1xmini-PCIe (full-size, auto switch to m-SATA) M.2 2230, SATA3 Compatible Operating system Microsoft Windows 10 (full), Windows IOT Core, Linux (ubinux, Ubuntu, Yocto), Android Marshmallow Dimensions 3.37" x 3.54" / 85.60 mm x 90 mm Certificate CE/FCC Class A, RoHS compliant, REACH
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UP² - Pinout

2	4	6	8	10	12	14	16	18	20	22	24	26	28	30	32	34	36	38	40
1	3	5	7	9	11	13	15	17	19	21	23	25	27	29	31	33	35	37	39
1 3V3	2 5V	3 GPIO0/ I2C1_SDA	4 5V	5 GPIO1/ I2C1_SCL	6 Ground	7 GPIO2/ ADC*_in1	8 GPIO15/ UART_TXD	9 Ground	10 GPIO16/ UART_RXD	11 GPIO3/ UART_RTS/ SPI_2_FS1*/ ADC*_in2	12 GPIO17/ I2S_BCLK/ SPI_2_FS0*	13 GPIO4/ ADC*_in3	14 Ground	15 GPIO5/ ADC**_in4	16 GPIO18	17 3V3	18 GPIO19	19 GPIO6/ SPI_1_TXD	20 Ground
21 GPIO7/ SPI_1_RXD	22 GPIO20	23 GPIO8/ SPI_1_CLK	24 GPIO21/ SPI_1_FS0	25 Ground	26 GPIO22/ SPI_1_FS1	27 GPIO9/ I2C0_SDA	28 GPIO23/ I2C0_SCL	29 GPIO10	30 Ground	31 GPIO11	32 GPIO24/ PWM0	33 GPIO12/ PWM1	34 Ground	35 GPIO13/ I2S_WS_SYNC/ SPI_2_RXD*	36 GPIO25/ UART_CTS/ SPI_2_FS2*	37 GPIO14	38 GPIO26/ I2S_SDI/ SPI_2_TXD*	39 Ground	40 GPIO27/ I2S_SDO/ SPI_2_CLK*

* 2nd SPI and ADC will be available only with E3940 SoC

UPS-APLC2-A20-0232
RE-UPS-APLC2-A10-0432
UPS-APLX5-A20-0432
RE-UPS-APLX7-A10-0464
RE-UPS-APLX7-A10-0464-VINO01

Celeron N3350 2GB memory/32GB eMMC
Celeron N3350 4GB memory/32GB eMMC
Atom x5-E3940 4GB memory/32GB eMMC
Atom x7-E3950 4GB memory/64GB eMMC
Atom x7-E3950 4GB memory/64GB eMMC with Ubuntu Image

RE-UPS-APLP4-A10-0432
UPS-APLP4-A10-0864
UPS-APLP4-A20-08128
RE-UPS-APLP4-A10-0864-VN01

Pentium N4200 4GB memory/32GB eMMC
Pentium N4200 8GB memory/64GB eMMC
Pentium N4200 8GB memory/128GB eMMC
Pentium N4200 8GB memory/64GB eMMC with Ubuntu Image

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